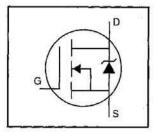
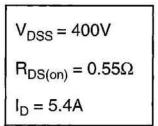
# International Rectifier

# IRFI740GPbF

#### HEXFET® Power MOSFET

- Isolated Package
- High Voltage Isolation= 2.5KVRMS ®
- Sink to Lead Creepage Dist.= 4.8mm
- Dynamic dv/dt Rating
- Low Thermal Resistance
- Lead-Free

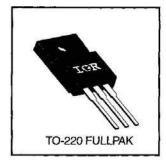




#### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 Fullpak eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The Fullpak is mounted to a heatsink using a single clip or by a single screw fixing.



#### **Absolute Maximum Ratings**

	Parameter	Max.	Units	
ID @ TC = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10 V 5.4			
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, VGS @ 10 V	3.4	A	
I <sub>DM</sub>	Pulsed Drain Current ①	22		
Pp @ Tc = 25°C	Power Dissipation	40	W	
277-22 32-27 23 252	Linear Derating Factor	0.32	W/°C	
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V	
Eas	Single Pulse Avalanche Energy ②	390	mJ	
IAR	Avaianche Current ①	5.4	A	
EAR	Repetitive Avalanche Energy ①	4.0	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	4.0	V/ns	
T <sub>J</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

#### Thermal Resistance

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	Parameter	Min.	Typ.	Max.	Units
Reuc	Junction-to-Case		-	3.1 65	°C/W
ReJA	Junction-to-Ambient				

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### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	400	-	76_5	٧	V <sub>GS</sub> =0V, I <sub>D</sub> = 250μA	
ΔV <sub>(BR)DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temp. Coefficient	_	0.49	15_2	V/°C	Reference to 25°C, ID= 1mA	
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance	-	_	0.55	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =3.2A ④	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0	-	4.0	٧	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = 250μA	
gls .	Forward Transconductance	3.6	_	-	S	V <sub>DS</sub> =50V, I <sub>D</sub> =3.2A @	
1222	Drain to Sauras Laskaga Current	1 1 <del></del>		25		V <sub>DS</sub> =400V, V <sub>GS</sub> =0V	
loss	Drain-to-Source Leakage Current	-	-	250	μА	V <sub>DS</sub> =320V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C	
12	Gate-to-Source Forward Leakage		1 <del></del>	100	nA	V <sub>GS</sub> =20V	
lgss	Gate-to-Source Reverse Leakage	S	-	-100	nA	V <sub>GS</sub> =-20V	
Q <sub>9</sub>	Total Gate Charge	-	-	66		I <sub>D</sub> =10A	
Qgs	Gate-to-Source Charge	V-20		10	nÇ	V <sub>DS</sub> =320V	
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge	8444	-	33		V <sub>GS</sub> =10V See Fig. 6 and 13 @	
t <sub>d(on)</sub>	Turn-On Delay Time	-	14	_		V <sub>DD</sub> =200V	
tr	Rise Time	:	25	-	ns	I <sub>D</sub> =10A	
t <sub>d(off)</sub>	Turn-Off Delay Time	-	54	_	113	R <sub>G</sub> =9.1Ω	
t <sub>f</sub>	Fall Time	-	24	_		R <sub>D</sub> =20Ω See Figure 10 @	
L <sub>D</sub>	Internal Drain Inductance	-	4.5	_	nН	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance	3==	7.5	-	1111	from package and center of die contact	
Ciss	Input Capacitance	_	1200			V <sub>GS</sub> =0V	
Coss	Output Capacitance	-	230		pF	V <sub>DS</sub> = 25V f=1.0MHz See Figure 5	
Crss	Reverse Transfer Capacitance	-	48	-			
С	Drain to Sink Capacitance	10-0	12	-	pF	f=1.0MHz	

#### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
ls	Continuous Source Current (Body Diode)		=	5.4		MOSFET symbol showing the	
Ism	Pulsed Source Current (Body Diode) ①	_	_	22	Α	integral reverse p-n junction diode.	
V <sub>SD</sub>	Diode Forward Voltage		_	2.0	٧	TJ=25°C, IS=5.4A, VGS=0V @	
t <sub>rr</sub>	Reverse Recovery Time		330	730	ns	T <sub>J</sub> =25°C, I <sub>F</sub> =10A di/dt=100A/μs @	
Qrr	Reverse Recovery Charge		2.8	6.6	μC		
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+LD)					

#### Notes:

- Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ I<sub>SD</sub>≤10A, di/dt≤120A/ $\mu$ s, V<sub>DD</sub>≤V(BR)DSS, T<sub>J</sub>≤150°C
- ⑤ t=60s, f=60Hz

- ②  $V_{DD}$ =50V, starting  $T_J$ =25°C, L=23mH  $R_G$ =25 $\Omega$ ,  $I_{AS}$ =5.4A (See Figure 12)
- ④ Pulse width ≤ 300 µs; duty cycle ≤2%.

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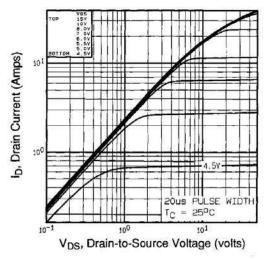


Fig 1. Typical Output Characteristics, T<sub>C</sub>=25°C

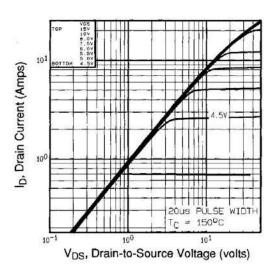


Fig 2. Typical Output Characteristics, T<sub>C</sub>=150°C

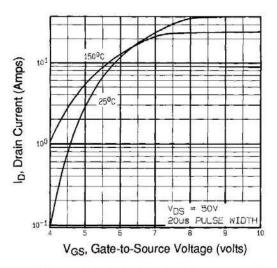


Fig 3. Typical Transfer Characteristics

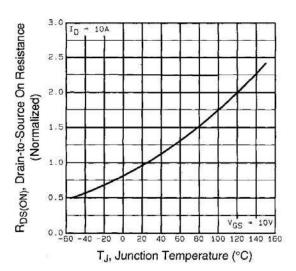


Fig 4. Normalized On-Resistance Vs. Temperature

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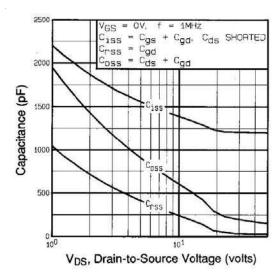


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

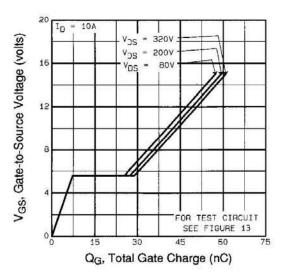


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

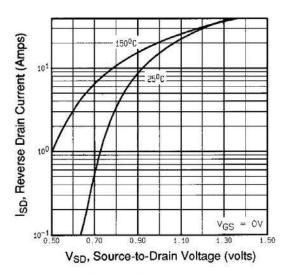


Fig 7. Typical Source-Drain Diode Forward Voltage

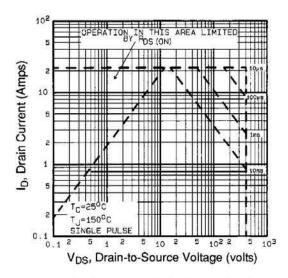


Fig 8. Maximum Safe Operating Area

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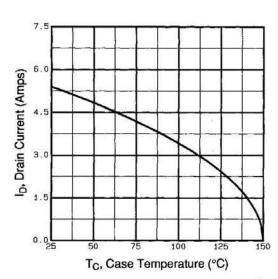


Fig 9. Maximum Drain Current Vs. Case Temperature

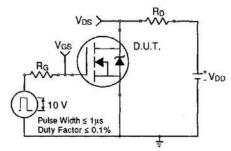


Fig 10a. Switching Time Test Circuit

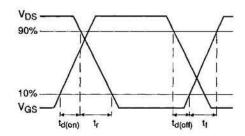
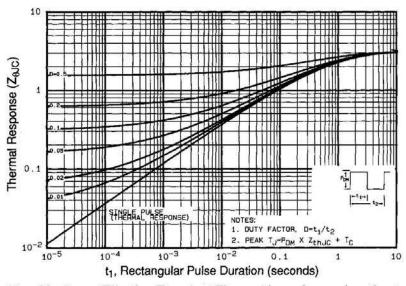


Fig 10b. Switching Time Waveforms



Maximum Effective Transient Thermal Impedance, Junction-to-Case

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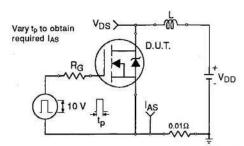


Fig 12a. Unclamped Inductive Test Circuit

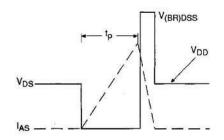


Fig 12b. Unclamped Inductive Waveforms

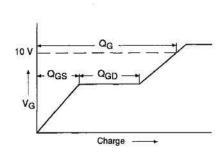


Fig 13a. Basic Gate Charge Waveform

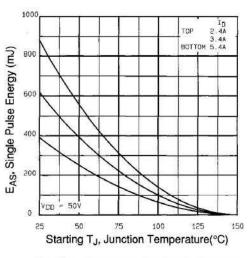


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

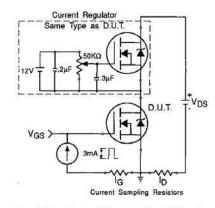


Fig 13b. Gate Charge Test Circuit

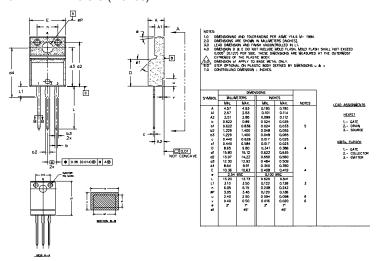
Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1505

Appendix B: Package Outline Mechanical Drawing - See page 1510

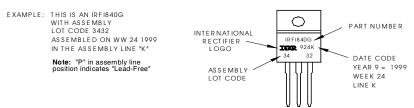
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## TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)



## TO-220 Full-Pak Part Marking Information



Data and specifications subject to change without notice.



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